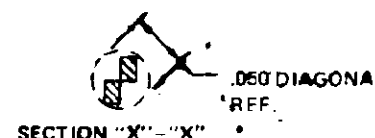
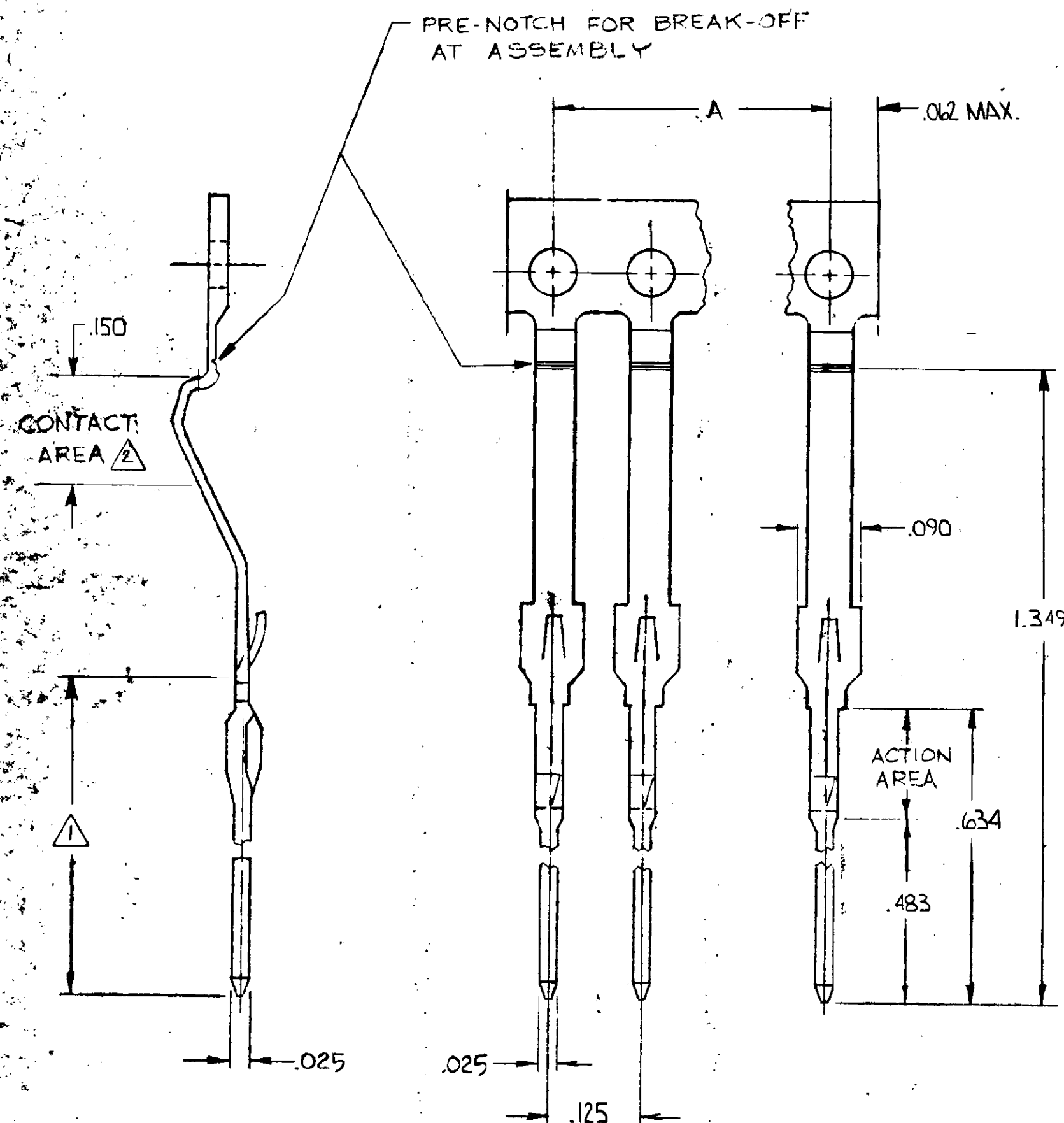


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REVISIONS				
P	ZONE	LTR	DESCRIPTION	DATE APPROVED
0			REL / PP 496	5-9-79 L. Brown



NOTE:
REFER TO AMP
SPEC. 106-14018
OR 106-14019,
AS APPLICABLE,
FOR SPECIFIC
HOLE SIZE
RECOMMENDATIONS.

ACTION PIN AREA

1. .000100 MIN. SOLDER PLATE (60% Sn/40 Pb OR 93.5 Sn/7 Pb) ON POST / MIN. OF .045 ABOVE ACTION PIN AREA.
2. .000075 GOLD PLATE OVER .000100 NICKEL PLATE IN .150 CONTACT AREA ONLY. (FACE ONLY)
3. ALL DIMENSIONS ARE REF UNLESS OTHERWISE SHOWN.

3.250 27 118811-1
A POSN PART NO

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES. TOLERANCES ON: DECIMALS ± ANGLES ±	CONTRACT NO	AMP INCORPORATED Harrisburg, Pa.	
MATERIAL CDA COPPER ALLOY 725	DR Leroy B. Brown 5-8-79	NAME COMB, CONTACT ECONOMATE I (DA)	
FINISH NOTES 32	CHK Q. R. L. 18 MAY 1979	WRAP TYPE POST, .025 SQ. (.125 x .125)	
	APPD	SIZE C	CODE IDENT NO 00779
	APPD	DRAWING NO 118811	
	DSGN APPD	SCALE	SHEET
	OTHER APPD		